

ORGANIZING INFORMATION

THE SEMINAR IS HELD AT:

Střední škola informatiky
Čichnova 23, 624 00 BRNO-Komín

How to get there: see incl. plan by a car

From the Brno Trade Fair Exhibition Centre go in direction Brno-dam. After approx. 4 km you will see the OPEL car shop centre, on the left side. At the crossroads in front of the OPEL go to the left, at the next crossroads to the right and on the right side you will see an educational centre:

Střední škola informatiky
street Čichnova 23, BRNO-Komín

BINDING APPLICATIONS:

Will be mailed together with obligatory demand for accommodation and meals before **February 19, 2018** to the address:

SMT-INFO consortium
Údolní 53, 602 00 Brno
CZECH REPUBLIC
e-mail: smtinfo@nexta.cz

Accommodation with meals:

Participants will be accommodated in the BOBY CENTRUM Brno ***

Registration:

In the seminar hall
February 21, 2018 8.30 a.m.

PROFESSIONAL GUARANTOR:

SMT-INFO, Údolní 53, 602 00 Brno
CZECH REPUBLIC

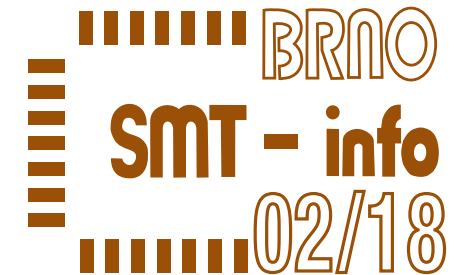
tel.: 00420-541 146 113
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e-mail: smtinfo@nexta.cz
Internet: www.smtinfo.cz

SMT-INFO CONSORTIUM

in cooperation with

FEKT VUT Brno
and
SŠ INFORMATIKY BRNO

have the pleasure to invite you
for the twenty-seventh cycle
new techniques & technologies presentation



PCB DESIGN SYSTEMS

**PCB PRODUCTION
AND DEFECTS**

**COMPLEX PRODUCTION LINES
FOR MODERN ASSEMBLY**

INSPECTION SYSTEMS

BRNO, February 21, 2018
SŠ informatiky
Čichnova 23, Brno-Komín

event. code 02/18

SMT-INFO consortium
Údolní 53
602 00 BRNO
Czech Republic

SEMINAR ORIENTATION:

- PCB DESIGN SYSTEMS
- PCB PRODUCTION AND DEFECTS
- COMPLEX PRODUCTION LINES FOR MODERN ASSEMBLY
- PICK AND PLACE MACHINES, SCREEN PRINTERS, DISPENSERS
- INSPECTION SYSTEMS

PROFESSIONAL OFFER

- Seminar participants will be acquainted with the latest information on above mentioned topics presented by specialist from prestigious companies.
- In a room adjacent the lecture theatre, the following company stands will be installed and professional literature and demonstration equipment will be offered there:

ADOPT SMT

- Advertisement tables will be available for the seminar participants and visitors, providing propagation of their own products and offer of non-used/used technological equipment and services.

THEMATIC ORIENTATION OF OTHER EVENTS ORGANIZED BY SMT-INFO:

SMT-INFO 10/18 Conference, Brno 16.–17.10. 2018

- SOLDERING AND CLEANING IN ELECTRONICS
- NEW TRENDS IN MICROELECTRONICS
- TECHNIQUES IN REPAIRING
- SOLDER JOINT DEFECTS

PROFESSIONAL GUARANTOR:

SMT-INFO CONSORTIUM, Údolní 53, 602 00 Brno
mobil: 00420-602 542 966
e-mail: smtinfo@nexta.cz
internet: www.smtinfo.cz

SEMINAR SCHEDULE

Wednesday, February 21, 2018

- 9.00 - Opening, Introduction
- 9.05 - How to Select FR4 Base Material /J. Starý, FEKT VUT Brno/
- 9.20 - ASYMTEK – New Solutions for Electronics Manufacturing /A. Nagy, NORDSON ASYMTEK, J. Vondráček, AMTEST GROUP Brno/
- 9.50 - Break, Coffee, Refreshment
- 10.10 - “A small Selection Guide for 3D AOI/SPI Technology“ /M. Drlík, IMT TECHNOLOGIES AND SOLUTIONS, Valašské Meziříčí/
- 10.50 - New Generation of Pick and Place Machines MY300, MY700 JetPrinter from MYCRONIC SE /A. Casimiro, MYCRONIC SE, P. Malysz, MP ELEKTRONIK TECHNOLOGIE Blansko/
- 11.20 - Discussion
- 11.30 - PARMI 3D AOI Technology Advantages /P. Lacko, QUIPTECH Brno/
- 12.00 - Pick and Place Machines E by SIPLACE and Screen Printers E by DEK /R. Kratochvíl, NETA Brno/
- 12.40 - SMD Tower Storage /P. Malysz, MP ELEKTRONIK TECHNOLOGIE Blansko/
- 12.50 - How to Effectively Controll Production Growth /D. Striček, PBT Rožnov p. Radh./
- 13.20 - Electrostatic Phenomenons – Problems, Risk and Application /K. Jurák, Praha + Z. Nejezchlebová, AGENTURA ČAS Praha/
- 13.40 - Discussion, Seminar Closing
- Lunch

Lectures in English and German will be interpreted. Program changes reserved.

Obligatory application for international seminar

PCB DESIGN SYSTEMS

PCB PRODUCTION AND DEFECTS

COMPLEX PRODUCTION LINES FOR MODERN ASSEMBLY

INSPECTION SYSTEMS

February 21, 2018

Name and surname, title

Factory name and address (ZIP code)

Job function

Telephone Telefax

e-mail

Lunch

February 21, 2018

yes-no

.....
Participant signature

.....
Stamp and signature
of the organization